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By: *[Signature]*

Date: June 24, 2003

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Gottfried Ferber et al.
Applic. No. : 10/056,770
Filed : January 24, 2002
Title : Semiconductor Module and Method for
Fabricating the Semiconductor Module
Examiner : Long K. Tran
Group Art Unit : 2818

A M E N D M E N T

Hon. Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

S i r :

Responsive to the Office action dated March 26, 2003 kindly
amend the above-identified application as follows:

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TECHNOLOGY CENTER 2800